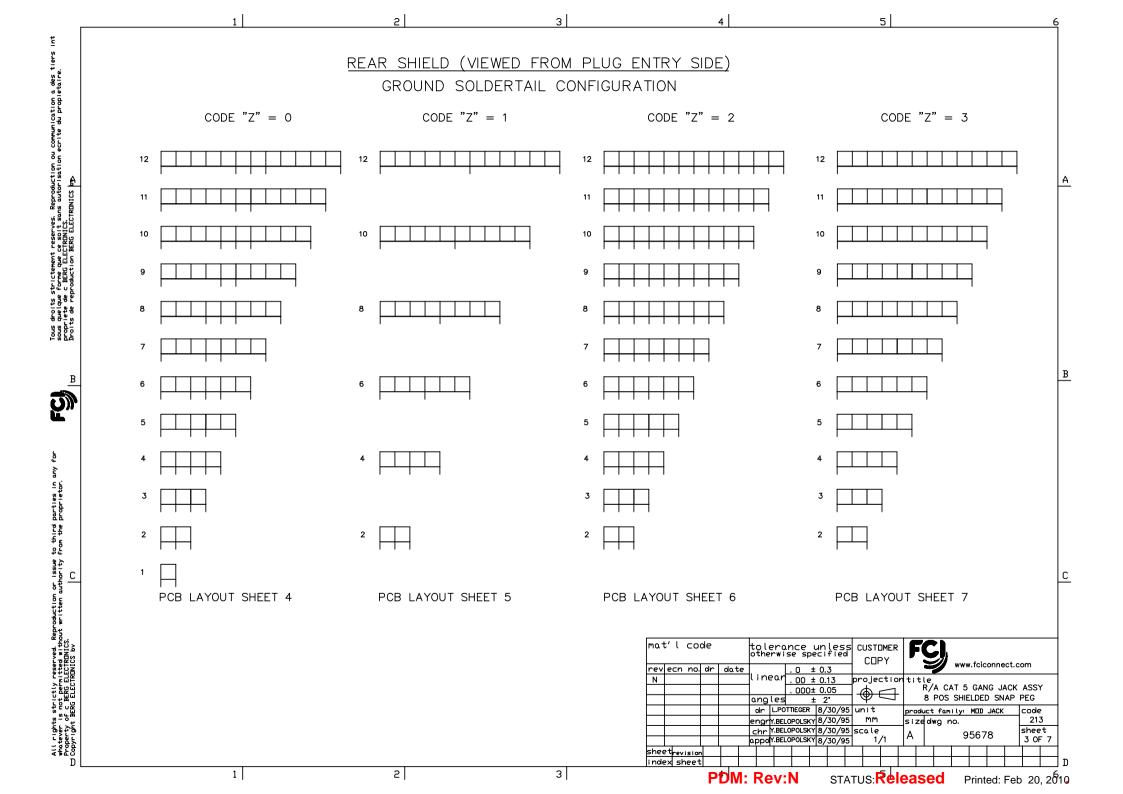
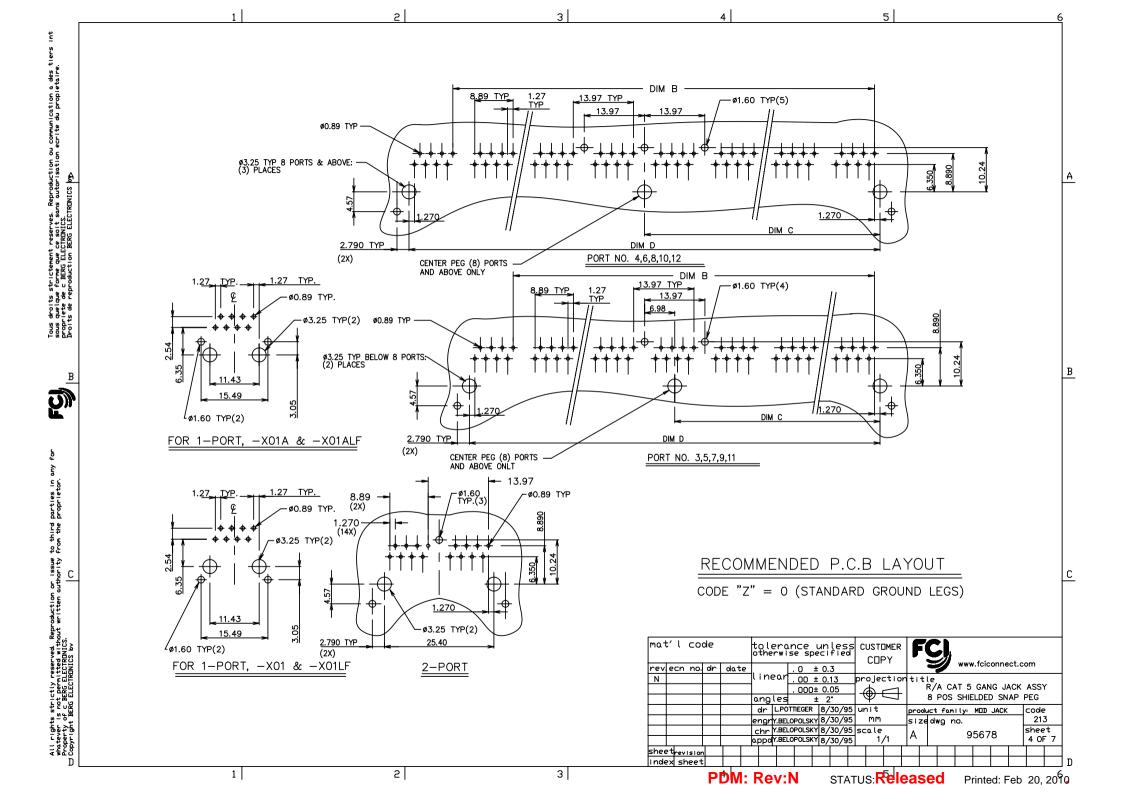
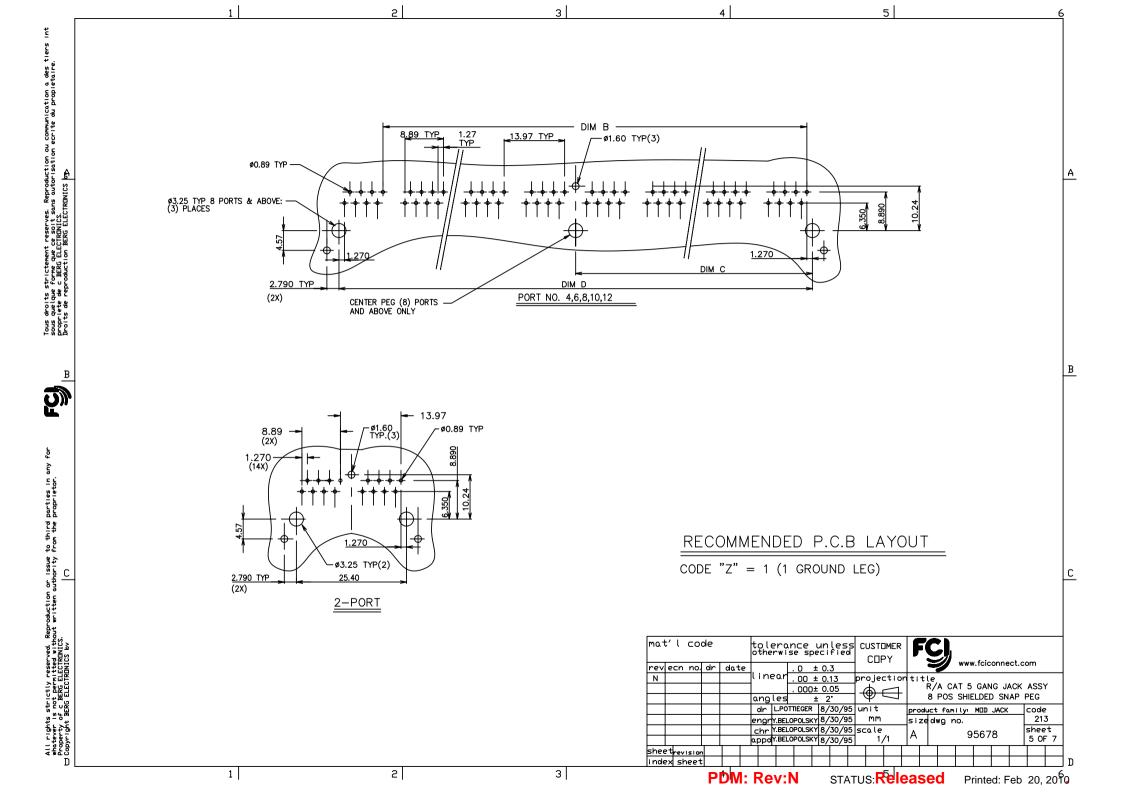
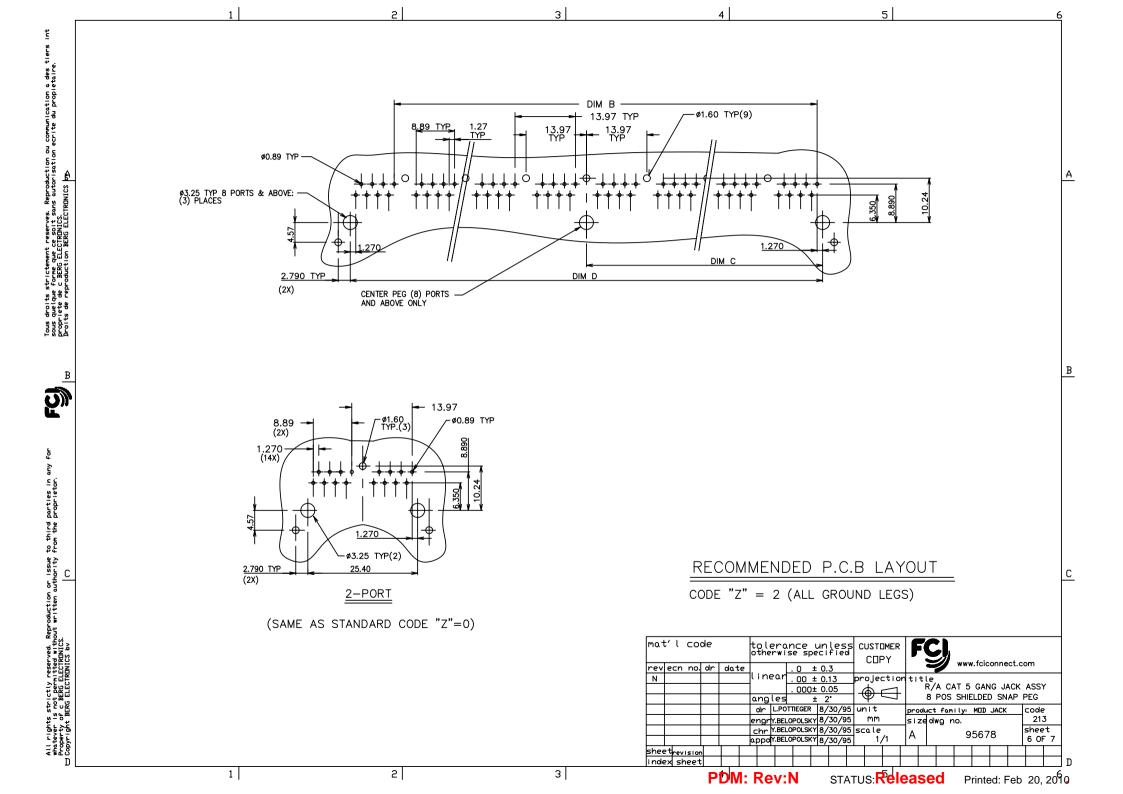


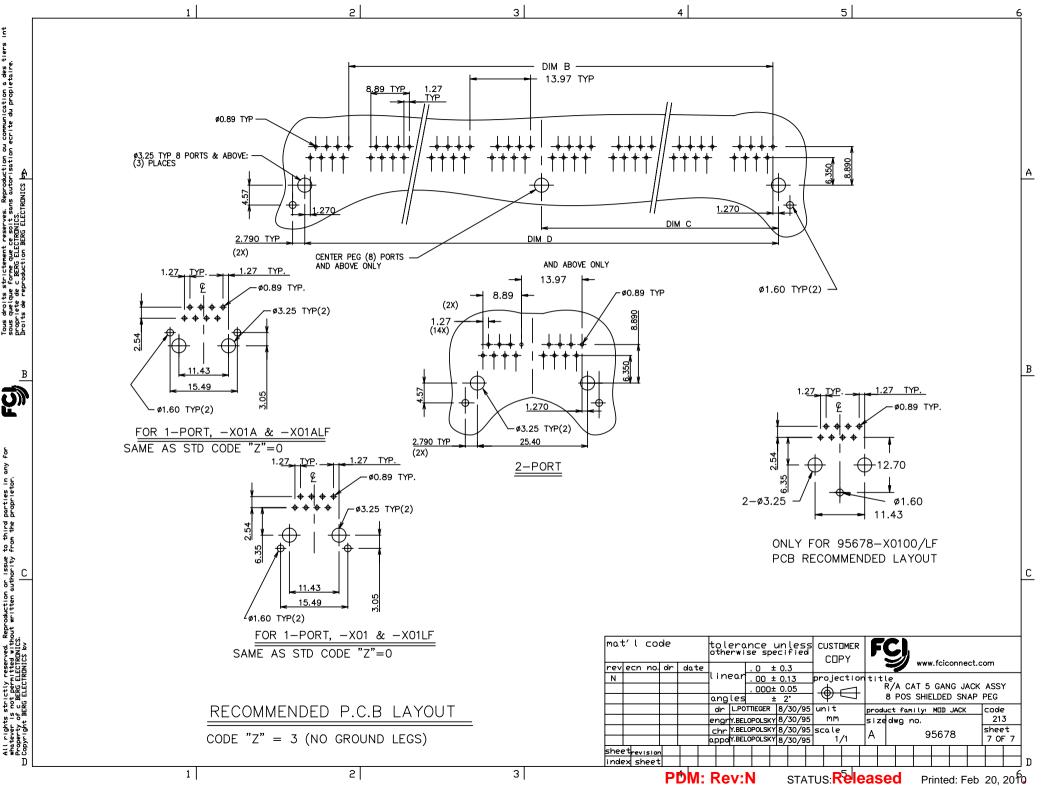
		1		1	2	1	3 4 5
PRODUCT NO	PORTS NO	DIA A +.60	DIM B	DIM C±0.10	DIM D±0.15	GROUND LEG NUMBER ON THE BACK (VIEW B)	
95678-X01 95678-X01LF 95678-X01NLF 95678-X0100	1	15.74	_	5.715	11.43	SEE DIAGRAM ON SHT. 3	NOTE 5
95678-X0100LF 95678-X01A 95678-X01ALF	1	15.74	_	5.715	11.43	ł	NOTE 5
95678-X01ANLF 95678-X02YZ 95678-X02YZLF 95678-X02NYZLF	2	30.98	13.97	12.700	25.40		NOTES: 1. RECOMMENDED P.C.B THICKNESS 1.60 MM.
95678-X02N12LF 95678-X03YZ 95678-X03YZLF 95678-X03NYZLF	3	44.95	27.94	19.685	39.37		2. HOUSING MAT'L: HIGH TEMP RESIN. 3. CONTACTS: PHOS BRONZE ALLOY UNS-C51000,
95678-X04YZ 95678-X04YZLF 95678-X04YZLF 95678-X04NYZLF	4	58.92	41.91	26.670	53.34		 Ø 0.460 ROUND WIRE, PLATING SEE TABLE. (4.) SHIELD MATL: BRASS ALLOY, .25 MM THICK.
95678-X05YZ 95678-X05YZLF 95678-X05YZLF 95678-X05NYZLF	5	72.89	55.88	33.655	67.31		SHIELD PLATING: -FOR 95678-X01 THRU 95678-X12YZ
95678-X05NTZLF 95678-X06YZ 95678-X06YZLF 95678-X06NYZLF	6	86.86	69.85	40.640	81.28		BRIGHT TIN LEAD, 100u"MIN OVER NICKEL. LEAD FREE OPTION: -FOR 95678-X01NLF THRU 95678-X12NYZLF
95678-X07YZ 95678-X07YZLF 95678-X07YZLF	7	100.83	83.82	47.625	95.25		NICKEL, 30U"MIN WITH SELECTIVE TIN ON SOLDER TAILS. SEE DETAIL E.
95678-X08YZ 95678-X08YZLF 95678-X08YZLF	8	114.80	97.79	54.610	109.22		-FOR 95678-X01LF THRU 95678-X12YZLF BRIGHT PURE TIN, 800"MIN OVER NICKEL. (5) SEE SIDE VIEW ON SHT. 1 FOR DETAILS.
95678-X09YZ 95678-X09YZLF 95678-X09NYZLF	9	128.77	111.76	61.595	123.19		6. ALL DIMENSIONS IN MILLIMETER.
95678-X10YZ 95678-X10YZLF 95678-X10NYZLF	10	142.74	125.73	68.580	137.16		(7.) COMPANY LOGO LOCATED IN THIS AREA.8. PART NUMBERS WITH LF IN THE END ARE LEAD FREE.
95678-X11YZ 95678-X11YZLF 95678-X11NYZLF	11	156.71	139.70	75.565	151.13		9. LEAD FREE STATEMENT: THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AN OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008.
95678–X12YZ 95678–X12YZLF 95678– <u>X</u> 12N <u>YZ</u> LF	12	170.68	153.67	82.550	165.10		10. THE HOUSING TEMPERATURE WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5 MM MINIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/PROCEDURES
							IF THEY ARE AVAILABLE. ①. EQUIVALENT THICKNESS AU AND GXT PLATING HAVE SAME FUNCTION AND THEY ARE ALTERNATIVE BY THE CUSTOEMR .
PLATING CODE X	PLATIN	G	F	RONT SHIELD	CODE Y	REAR SHIE	LD CODE Z
0	30u" G.			NDARD GRND.	TABS	0 = STANDARD	
1 3	15u" GC 30u" GC		I = NO	GRND. TABS		1 = 1 GRND. L $2 = ALL GRND.$	
5	50u GC					3 = NO GRND.	
NOTE: PLEASE CHEC VAILABLE.	CK FOR AV	YAILABILITY, N	OT ALL O	PTIONS			mat'l code tolerance unless otherwise specified CUSTUMER CUPY FS www.fciconnect.com revecn no. dr date .0 ± 0.3 CDPY FS www.fciconnect.com N linear .00 ± 0.13 projection title N angles ± 2* B POS SHIELDED SNAP PEG dr LPOTTEGER 8/30/95 mnit engry.BELOPOLSKY 8/30/95 mm size dwg no. 213 chr Y.BELOPOLSKY 8/30/95 1/1 A 95678 206
							sheet lindex sheet
		1			2		³ PDM: Rev:N STATUS: Released Printed: Feb 20, 2010











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